

# Power line chokes

Current-compensated frame core double chokes 250 V AC, 0.45 ... 1.6 A, 10 ... 100 mH, +40 °C

Series/Type: B82732F

Date: March 2021

<sup>©</sup> TDK Electronics AG 2021. Reproduction, publication and dissemination of this publication, enclosures hereto and the information contained therein without TDK Electronics' prior express consent is prohibited.



Power line chokes B82732F

#### **Current-compensated frame core double chokes**

Rated voltage 250 V AC Rated current 0.45 ... 1.6 A (+40 °C) Rated inductance 10 ... 100 mH

#### Construction

- Current-compensated frame core double choke
- Closed magnetic circuit with frame construction made of ferrite
- Plastic coil former (UL94 V-0)
- 4-section winding with direct winding on the core
- Sector winding
- Clearance and creepage distances >3 mm

#### **Features**

- High inductance with low resistance
- Approx. 2% stray inductance for symmetrical interference suppression
- High pulse-handling capability
- Very good inductance/rated current ratio
- Low height (13.5 mm)
- Suitable for wave soldering
- Design complies with EN 60938-2 (VDE 0565-2) and UL 1283
- ENEC (VDE) and UL<sup>1)</sup> approval **X**<sup>1</sup>
- RoHS-compatible

### **Applications**

- Suppression of common-mode and differential-mode interferences
- Electronic ballasts for lamps
- Compact switch-mode power supplies for consumer electronics

#### **Terminals**

- Base material CP wire
- Hot dipped
- Pins 0.7 × 0.7 mm
- Lead spacing 10 × 18.75 mm

#### Marking

Product brand, date of manufacture (YYWWD), production place identification code, ordering code, approval signs

#### **Delivery mode**

Blister tray (anti-static) in cardboard box

1) UL approval with 300 V AC

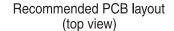


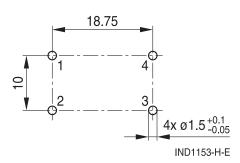


Power line chokes B82732F

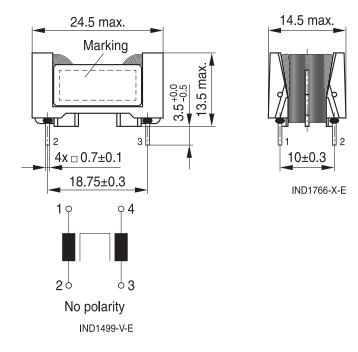
### **Current-compensated frame core double chokes**

#### Dimensional drawing and layout recommendation





Tolerances to ISO 2768-cl / ISO 8015. Size ISO 14405 © All dimensions in mm



#### Technical data and measuring conditions

Rated voltage V <sub>R</sub>	250 V AC (50/60 Hz)			
Test voltage V <sub>test</sub>	2000 V AC, 2 s (line/line)			
Rated temperature T <sub>R</sub>	+40 °C			
Rated current I <sub>R</sub>	Referred to 50 Hz and rated temperature			
Rated inductance L <sub>R</sub>	Measured with Agilent 4284A at 10 kHz, 0.1 mA, +20 °C. Inductance is specified per winding.			
Inductance tolerance	-30/+50% at +20 °C			
Inductance decrease ΔL/L <sub>0</sub>	< 10% at DC magnetic bias with I <sub>R</sub> , +20 °C			
Stray inductance L <sub>stray,typ</sub>	Measured with Agilent 4284A at 10 kHz, 5 mA, +20 °C, typical values			
DC resistance R <sub>typ</sub>	Measured at +20 °C, typical values, specified per winding			
Solderability (lead-free)	Sn96.5Ag3.0Cu0.5: +(245 $\pm$ 5) °C, (3 $\pm$ 0.3) s Wetting of soldering area $\geq$ 95% (to IEC 60068-2-20, test Ta)			
Resistance to soldering heat (wave soldering)	+(260 ±5) °C, (10 ±1) s (to IEC 60068-2-20, test Tb)			
Climatic category	40/125/56 (to IEC 60068-1)			
Storage conditions (packaged)	–25 °C +40 °C, ≤ 75% RH			
Weight	Approx. 10 g			
Approvals	EN 60938-2, UL 1283			
	·			



Power line chokes B82732F

#### **Current-compensated frame core double chokes**

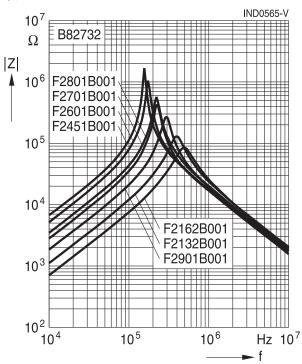
#### Characteristics and ordering codes

I <sub>R</sub>	L <sub>R</sub>	L <sub>stray,typ</sub>	R <sub>typ</sub>	Ordering code	Approvals	
Α	mH	μΗ	mΩ		<b>₽</b>	<i>7.</i> 1
0.45	100	1930	2930	B82732F2451B001	×	×
0.6	68	1340	1970	B82732F2601B001	×	×
0.7	47	920	1260	B82732F2701B001	×	×
8.0	39	760	1100	B82732F2801B001	×	×
0.9	27	520	770	B82732F2901B001	×	×
1.3	15	290	430	B82732F2132B001	×	×
1.6	10	200	290	B82732F2162B001	×	×

 $<sup>\</sup>times$  = approval granted

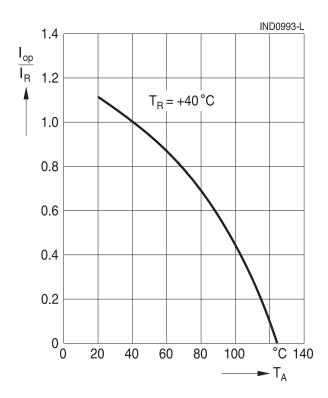
### Impedance |Z| versus frequency f

measured with windings in parallel at +20 °C typical values



## Current derating I<sub>op</sub>/I<sub>R</sub>

versus ambient temperature T<sub>A</sub>





#### **Cautions and warnings**

- Please note the recommendations in our Inductors data book (latest edition) and in the data sheets.
  - Particular attention should be paid to the derating curves given there.
  - The soldering conditions should also be observed. Temperatures quoted in relation to wave soldering refer to the pin, not the housing.
- If the components are to be washed varnished it is necessary to check whether the washing varnish agent that is used has a negative effect on the wire insulation, any plastics that are used, or on glued joints. In particular, it is possible for washing varnish agent residues to have a negative effect in the long-term on wire insulation.

  Washing processes may damage the product due to the possible static or cyclic mechanical loads (e.g. ultrasonic cleaning). They may cause cracks to develop on the product and its parts, which might lead to reduced reliability or lifetime.
- The following points must be observed if the components are potted in customer applications:
  - Many potting materials shrink as they harden. They therefore exert a pressure on the plastic housing or core. This pressure can have a deleterious effect on electrical properties, and in extreme cases can damage the core or plastic housing mechanically.
  - It is necessary to check whether the potting material used attacks or destroys the wire, wire insulation, plastics or glue.
  - The effect of the potting material can change the high-frequency behaviour of the components.
  - Many coating materials have a negative effect (chemically and mechanically) on the winding wires, insulation materials and connecting points. Customers are always obligated to determine whether and to what extent their coating materials influence the component. Customers are responsible and bear all risk for the use of the coating material. TDK Electronics does not assume any liability for failures of our components that are caused by the coating material.
- Ceramics / Ferrites are sensitive to direct impact. This can cause the core material to flake, or lead to breakage of the core.
- Even for customer-specific products, conclusive validation of the component in the circuit can only be carried out by the customer.

### Display of ordering codes for TDK Electronics products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications, on the company website, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products. Detailed information can be found on the Internet under www.tdk-electronics.tdk.com/orderingcodes.



#### Important notes

The following applies to all products named in this publication:

- 1. Some parts of this publication contain statements about the suitability of our products for certain areas of application. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application. As a rule, we are either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether a product with the properties described in the product specification is suitable for use in a particular customer application.
- 2. We also point out that in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
- The warnings, cautions and product-specific notes must be observed.
- 4. In order to satisfy certain technical requirements, some of the products described in this publication may contain substances subject to restrictions in certain jurisdictions (e.g. because they are classed as hazardous). Useful information on this will be found in our Material Data Sheets on the Internet (www.tdk-electronics.tdk.com/material). Should you have any more detailed questions, please contact our sales offices.
- 5. We constantly strive to improve our products. Consequently, the products described in this publication may change from time to time. The same is true of the corresponding product specifications. Please check therefore to what extent product descriptions and specifications contained in this publication are still applicable before or when you place an order. We also reserve the right to discontinue production and delivery of products. Consequently, we cannot guarantee that all products named in this publication will always be available. The aforementioned does not apply in the case of individual agreements deviating from the foregoing for customer-specific products.
- 6. Unless otherwise agreed in individual contracts, all orders are subject to our General Terms and Conditions of Supply.



#### Important notes

- 7. Our manufacturing sites serving the automotive business apply the IATF 16949 standard. The IATF certifications confirm our compliance with requirements regarding the quality management system in the automotive industry. Referring to customer requirements and customer specific requirements ("CSR") TDK always has and will continue to have the policy of respecting individual agreements. Even if IATF 16949 may appear to support the acceptance of unilateral requirements, we hereby like to emphasize that only requirements mutually agreed upon can and will be implemented in our Quality Management System. For clarification purposes we like to point out that obligations from IATF 16949 shall only become legally binding if individually agreed upon.
- 8. The trade names EPCOS, CarXield, CeraCharge, CeraDiode, CeraLink, CeraPad, CeraPlas, CSMP, CTVS, DeltaCap, DigiSiMic, ExoCore, FilterCap, FormFit, LeaXield, MiniBlue, MiniCell, MKD, MKK, ModCap, MotorCap, PCC, PhaseCap, PhaseCube, PhaseMod, PhiCap, PowerHap, PQSine, PQvar, SIFERRIT, SIFI, SIKOREL, SilverCap, SIMDAD, SiMic, SIMID, SineFormer, SIOV, ThermoFuse, WindCap, XieldCap are trademarks registered or pending in Europe and in other countries. Further information will be found on the Internet at www.tdk-electronics.tdk.com/trademarks.

Release 2020-06